

# MEMS & IMAGING SENSORS SUMMIT

## POST SHOW REPORT

MEMS & Imaging Sensors Summit | 25 - 27 Sep 2019 | Grenoble, France

### Event Highlights

- **400+** international registered attendees from **25** countries
- **4** executive keynotes and **50+** invited speakers
- **51** exhibitors (**41** exhibitors + 10 technology showcase companies)
- **10** MEMS/imaging/sensors-enabled technology demos
- **16** sponsors
- **30+** association and media partners
- **Networking opportunities** and **B2B matchmaking** onsite

### Executive Keynote Speeches

- **Digitize the Physical World**  
Yanchao Wang, Lead Solution Architect of Alibaba Cloud France Benelux and South Europe Region
- **Considerations of Optical Fingerprint and 3D Face Recognition Sensors for Cellular Security Applications**  
Avi Strum, Senior Vice President and General Manager of Sensors Business Unit, TowerJazz
- **Sensors in Mixed Reality**  
Sunil Acharya, Senior Director of Sensor Development HoloLens, Microsoft
- **A Touch of Finnish Sense**  
Antti Vasara, President & CEO, VTT

### 2019 MEMS & Sensors Technology Showcase

The Technology Showcase highlights some of the newest and most unique MEMS/imaging/sensors-enabled applications in the industry. The winners for the year 2019 were:

- MEMS/Sensors Technology - Okmetic Oy
- Imaging/Sensors Technology - Alertgy

Congratulations to Okmetic Oy & Alertgy and enjoy your free booth at MEMS & Imaging Sensors Summit 2020!

### Key Attending Companies

- |                     |                           |                                      |
|---------------------|---------------------------|--------------------------------------|
| • AIM Micro Systems | • Gpixel NV               | • RENA Technologies GmbH             |
| • Alibaba           | • Huawei Technologies     | • Robert Bosch GmbH                  |
| • AMEC              | • IBM                     | • SAES Getters S.p.A.                |
| • Amkor Technology  | • IHS Markit              | • SET Corporation SA                 |
| • ams AG            | • Infineon Technologies   | • Shanghai Industrial                |
| • Apple Inc.        | • Invest in Grenoble-Alps | • Siconnex customized solutions GmbH |
| • ASE Group         | • JSR Micro               | • Silvaco                            |
| • Beneq             | • Kokusai Semiconductor   | • Soitec                             |
| • BESI              | • KST World Corp.         | • Solmates BV                        |

- Cadence Design Systems
- Caeleste CVBA
- CEA - Leti
- DELO Industrial Adhesives
- DELTA
- Depixus
- Detection Technology
- Dow Silicones Deutschland
- EDA Solutions
- Entegris GmbH
- EV Group (EVG)
- Evatec Europe
- First Sensor
- Fraunhofer
- Frec'n'sys
- FRT GmbH
- FUJIFILM
- Lam Research
- Logitech
- MASER Engineering
- Mentor A Siemens Business
- Merck
- Micralyne Inc
- Microsoft, Inc.
- Murata Mfg.Co.,Ltd.
- NIKON
- NXP Semiconductors
- Onscale
- OPTIM Wafer Services
- OSAI A.S. S.p.A.
- Panasonic
- Philips
- Plasma-Therm
- Polyteknik AS
- Solvay
- Sony
- SPTS Technologies
- STMicroelectronics
- SÜSS MicroTec
- SVCS Process Innovation
- Takatori Corporation
- TDK, InvenSense
- Teledyne
- TOWERJAZZ
- Trymax
- USHIO INC.
- Von Ardenne GmbH
- VTT Ltd
- XPERI | InvenSas
- Yole Développement

## 2019 Sponsors



## 2019 Exhibitors



## 2019 Media Partners

